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Document Description
Schematic Checklist for the LAN91C96 Operating at +3.3V, 100-pin TQFP Package

 	SMSC 80 Arkay Drive Hauppauge, New York 11788	
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Schematic Checklist for LAN91C96

Information Particular for the 100-pin TQFP Package

LAN91C96 TQFP Phy Interface:

1. TPETXP (pin 75); This pin is the transmit twisted pair output positive connection from the internal phy. When operating the LAN91C96 at +3.3V, the device requires a 6.04Ω series resistor to the transmit channel positive of the magnetics (low pass filter side).
2. TPETXDP (pin 72); This pin is the transmit twisted pair output positive pre-distortion connection from the internal phy. When operating the LAN91C96 at +3.3V, the device requires a 24.3Ω series resistor to the transmit channel positive of the magnetics (low pass filter side).
3. These two outputs (TPETXP & TPETXDP) get resistively added together to form the TPO+ signal. They both connect, through their respective resistors, to the same pin of the magnetics. Refer to the latest SMSC reference schematic for details.
4. TPETXN (pin 73); This pin is the transmit twisted pair output negative connection from the internal phy. When operating the LAN91C96 at +3.3V, the device requires a 6.04Ω series resistor to the transmit channel negative of the magnetics (low pass filter side).
5. TPETXDN (pin 74); This pin is the transmit twisted pair output negative pre-distortion connection from the internal phy. When operating the LAN91C96 at +3.3V, the device requires a 24.3Ω series resistor to the transmit channel positive of the magnetics (low pass filter side).
6. These two outputs (TPETXN & TPETXDN) get resistively added together to form the TPO- signal. They both connect, through their respective resistors, to the same pin of the magnetics. Refer to the latest SMSC reference schematic for details.
7. TPERXP (pin 85); This pin is the receive twisted pair input positive connection to the internal phy. It requires a 100Ω termination resistor. This pin connects to the receive channel positive connection of the magnetics (low pass filter side).
8. TPERXN (pin 84); This pin is the receive twisted pair input negative connection to the internal phy. It requires a 100Ω termination resistor. This pin connects to the receive channel negative connection of the magnetics (low pass filter side).
9. Only one 100Ω receive termination resistor is required. Connect it between pins 85 & 84.

LAN91C96 TQFP 10BASE-T Magnetics:

1. The center tap connection on the LAN91C96 side (low pass filter side) for the transmit channel should be connected to digital ground through a .01 μ F capacitor.
2. The center tap connection on the LAN91C96 side (low pass filter side) for the receive channel should be connected to digital ground through a .01 μ F capacitor.
3. The center tap connection on the cable side (RJ45 side) for the transmit channel may be terminated with a 75Ω resistor through a 1000 ρ F, 2KV capacitor ($C_{magterm}$) to chassis ground. Another option (depending on magnetics selected) is to no-connect this center tap.
4. The center tap connection on the cable side (RJ45 side) for the receive channel may be terminated with a 75Ω resistor through a 1000 ρ F, 2KV capacitor ($C_{magterm}$) to chassis ground. Another option (depending on magnetics selected) is to no-connect this center tap.
5. Only one 1000 ρ F, 2KV capacitor ($C_{magterm}$) to chassis ground is required. It is shared by both TX & RX center taps.
6. Assuming the design of an end-point device (NIC), pin 1 of the RJ45 is TX+ and should trace through the magnetics to the TPO+ signal. Again, the TPO+ signal is derived from the resistive addition of pins 72 & 75 on the LAN91C96 TQFP.
7. Assuming the design of an end-point device (NIC), pin 2 of the RJ45 is TX- and should trace through the magnetics to the TPO- signal. Again, the TPO- signal is derived from the resistive addition of pins 73 & 74 on the LAN91C96 TQFP.
8. Assuming the design of an end-point device (NIC), pin 3 of the RJ45 is RX+ and should trace through the magnetics to TPERXP (pin 85) of the LAN91C96 TQFP.
9. Assuming the design of an end-point device (NIC), pin 6 of the RJ45 is RX- and should trace through the magnetics to TPERXN (pin 84) of the LAN91C96 TQFP.
10. It is very important to select the proper magnetics to use with the LAN91C96. The transformer must be a 10BASE-T type with Low Pass Filters. The Low Pass Filters are very important in guaranteeing the proper operation of the LAN91C96. The turns ratio of both transmit & receive channels must be 1:1. Please refer to the latest version of SMSC's "Suggested Magnetics" Application Note for recommended magnetics for the LAN91C96.

RJ45 Connector:

1. Pins 4 & 5 of the RJ45 connector connect to one pair of unused wires in CAT-5 type cables. These should be terminated to chassis ground through a 1000 pF, 2KV capacitor (C_{rjterm}). There are two methods of accomplishing this:
 - a) Pins 4 & 5 can be connected together with two 49.9 Ω resistors. The common connection of these resistors should be connected through a third 49.9 Ω to the 1000 pF, 2KV capacitor (C_{rjterm}).
 - b) For a lower component count, the resistors can be combined. The two 49.9 Ω resistors in parallel look like a 25 Ω resistor. The 25 Ω resistor in series with the 49.9 Ω makes the whole circuit look like a 75 Ω resistor. So, by shorting pins 4 & 5 together on the RJ45 and terminating them with a 75 Ω resistor in series with the 1000 pF, 2KV capacitor (C_{rjterm}) to chassis ground, creates an equivalent circuit.
2. Pins 7 & 8 of the RJ45 connector connect to one pair of unused wires in CAT-5 type cables. These should be terminated to chassis ground through a 1000 pF, 2KV capacitor (C_{rjterm}). There are two methods of accomplishing this:
 - a) Pins 7 & 8 can be connected together with two 49.9 Ω resistors. The common connection of these resistors should be connected through a third 49.9 Ω to the 1000 pF, 2KV capacitor (C_{rjterm}).
 - b) For a lower component count, the resistors can be combined. The two 49.9 Ω resistors in parallel look like a 25 Ω resistor. The 25 Ω resistor in series with the 49.9 Ω makes the whole circuit look like a 75 Ω resistor. So, by shorting pins 4 & 5 together on the RJ45 and terminating them with a 75 Ω resistor in series with the 1000 pF, 2KV capacitor (C_{rjterm}) to chassis ground, creates an equivalent circuit.
3. The RJ45 shield should be attached directly to chassis ground.

Crystal Connections:

1. A 20.000 MHz crystal must be used with the LAN91C96. For exact specifications and tolerances refer to the latest revision LAN91C96 data sheet.
2. XTAL1 (pin 94) on the LAN91C96 TQFP is the crystal circuit input. This pin requires a 10 – 30 pF capacitor to digital ground. One side of the crystal connects to this pin.
3. XTAL2 (pin 95) on the LAN91C96 TQFP is the crystal circuit output. We strongly recommend placing a 10 - 30 Ω resistor in series with this pin to the crystal for EMI purposes. The other side of the resistor can then connect to a matching 10 – 30 pF capacitor to ground and the other side of the crystal.
4. Since every system design is unique, the value for the series resistor is system dependant. The PCB design, the crystal selected, the layout and the type of caps selected all contribute to the characteristics of this circuit. Once the board is complete and operational, it is up to the system engineer to analyze this circuit in a lab environment. The system engineer should verify the frequency, the stability and the voltage level of the circuit to guarantee that the circuit meets all design criteria as put forth in the data sheet.

Attachment Unit Interface (AUI)

1. COLP (pin 81); This pin is the AUI collision positive differential input signal. It should connect directly to the COL+ connection on the AUI isolation transformer.
2. COLN (pin 80); This pin is the AUI collision negative differential input signal. It should connect directly to the COL- connection on the AUI isolation transformer.
3. RECP (pin 83); This pin is the AUI receive positive differential input signal. It should connect directly to the REC+ connection on the AUI isolation transformer.
4. RECN (pin 82); This pin is the AUI receive negative differential input signal. It should connect directly to the REC- connection on the AUI isolation transformer.
5. Also required across pins 82 & 83 of the LAN91C96 TQFP, is a 240 pF capacitor.
6. TXP (pin 77); This pin is the AUI transmit positive differential output signal. It should connect directly to the TXP connection on the AUI isolation transformer.
7. TXN (pin 76); This pin is the AUI transmit negative differential output signal. It should connect directly to the TXN connection on the AUI isolation transformer.
8. Pins 76 & 77 also require a resistive termination. Each pin requires a 154 Ω resistor to VCC for proper termination.
9. On the other side of the AUI isolation transformer, the system configuration is application dependant. In using a Coaxial Transceiver, the designer must implement as such. Please refer to the particular data sheets, application notes and/or other reference material for correct implementation of third party devices.

External Encoder/Decoder Interface (ENDEC)

1. The LAN91C96 may be used with an external ENDEC, one type is the 8023A style of Encoder / Decoder. To make this mode operational, pin 90 is the External Encoder/Decoder Mode input with an internal pull-up. This pin should be strapped high or left unconnected for normal operation (using the LAN91C96's internal encoder/decoder). Strapping this pin low configures the LAN91C96 to use an external encoder/decoder. This mode may also be referred to as a "7 wire interface".
2. RXD (pin 67); in this mode, this pin is an input to the LAN91C96 TQFP with an internal pull-up. Connect this pin to the receive data output pin of the external ENDEC selected.
3. RXCLK (pin 69); in this mode, this pin is an input to the LAN91C96 TQFP with an internal pull-up. Connect this pin to the receive clock output of the external ENDEC selected.
4. TXD (pin 68); in this mode, this pin is an output of the LAN91C96 TQFP. Connect this pin to the transmit data input pin of the external ENDEC selected.
5. TXCLK (pin 66); in this mode, this pin is an input to the LAN91C96 TQFP with an internal pull-up. Connect this pin to the transmit clock output pin of the external ENDEC selected.
6. nTXEN (pin 70); in this mode, this pin is an active low output of the LAN91C96 TQFP. Connect this pin to the transmit enable input of the external ENDEC selected.
7. nCOLL (pin 77); in this mode, this pin is an active low input to the LAN91C96 TQFP. Connect this pin to the collision sense output of the external ENDEC selected.
8. nCRS (pin 76); in this mode, this pin is an active low input to the LAN91C96 TQFP. Connect this pin to the carrier sense output of the external ENDEC selected.
9. The rest of the design around the external ENDEC is application dependant. In using a Coaxial Transceiver, the designer must implement as such. Please refer to the particular data sheets, application notes and/or other reference material for correct implementation of third party devices.

Power Connections:

1. VDD pins on the LAN91C96 TQFP are 11, 19, 38, 48, 59 & 98. They require connection to +3.3V.
2. Each power pin should have one .01 μ F (or smaller) capacitor to decouple the LAN91C96. The capacitor size should be SMD_0603 or smaller.
3. AVDD pins on the LAN91C96 TQFP are 71, 79 & 89. They require connection to +3.3V.
4. Each AVDD pin should have one .01 μ F (or smaller) capacitor to decouple the LAN91C96. The capacitor size should be SMD_0603 or smaller.
5. Unless there are some issues with EMI problems, we recommend tying the VDD & the AVDD pins together and connect them to a +3.3V power plane.
6. If EMI problems are encountered, ferrite beads may be placed in series with the voltage connections of the VDD pins or the AVDD pins or both. This may or may not pay dividends at EMI testing. If ferrite beads are used, be certain to place bulk capacitors on each side of the ferrite bead.

Ground Connections:

1. Digital Ground pins on the LAN91C96 TQFP are 6, 16, 22, 29, 54, 64, 92 & 100. They need to be connected directly to a solid ground plane.
2. AVSS pins on the LAN91C96 TQFP are 78, 86 & 87. They need to be connected directly to a solid ground plane.
3. We recommend that the Digital Ground pins and the AVSS pins be tied together to the same ground plane.

EEPROM Interface:

1. EECs (pin 4) on the LAN91C96 TQFP connects to the external EEPROM's CS pin.
2. EESK (pin 5) on the LAN91C96 TQFP connects to the external EEPROM's serial clock pin.
3. EEDO (pin 2) on the LAN91C96 TQFP connects to the external EEPROM's Data In pin.
4. EEDI (pin 3) on the LAN91C96 TQFP connects to the external EEPROM's Data Out pin.
5. Be sure to strap the external EEPROM for 64 x 16 operation.
6. In order to use the EEPROM interface, be sure ENEEP (pin 1) can be strapped high. This input of the LAN91C96 TQFP has an internal pull-up. If no serial EEPROM is used, this pin must tied to ground.
7. ISO0 (pin 96), ISO1 (pin 97) & ISO2 (pin 99) control what data is used from the EEPROM. Strap these pins to a known state. These inputs to the LAN91C96 TQFP have internal pull-ups.

RBIAS Resistor:

1. RBIAS (pin 88) on the LAN91C96 TQFP should connect to digital ground through a 2.43K Ω resistor.

Required External Pull-ups:

1. IOCHRDY/nWAIT (pin 53) is an open-drain output of the LAN91C96 TQFP. An external pull-up resistor is required for this signal.
2. nIOCS16/nIOIS16 (pin 23) is an open-drain output of the LAN91C96 TQFP. An external pull-up resistor is required for this signal.
3. nBSELED (pin 67); This open-drain, active low output of the LAN91C96 TQFP indicates the system is being accessed. Connect this pin to the cathode side of a LED and the anode side of the LED through a 332 Ω resistor to +3.3V.
4. nLNKLED (pin 68); This open-drain, active low output of the LAN91C96 TQFP indicates that link connection has been made in the Ethernet interface. Connect this pin to the cathode side of a LED and the anode side of the LED through a 332 Ω resistor to +3.3V.
5. nTXLED (pin 70); This open-drain, active low output of the LAN91C96 TQFP indicates that the device is transmitting data in the Ethernet interface. Connect this pin to the cathode side of a LED and the anode side of the LED through a 332 Ω resistor to +3.3V.
6. nRXLED (pin 69); This open-drain, active low output of the LAN91C96 TQFP indicates that the Ethernet interface is either transmitting or receiving data. This pin can be considered an Activity indicator, contrary to data sheet information. Connect this pin to the cathode side of a LED and the anode side of the LED through a 332 Ω resistor to +3.3V.

CPU Interface:

1. A0 – A19 Address Bus: Please refer to the latest revision of the LAN91C96 Application Note for exact implementation of the CPU interface selected.
2. D0 – D15 Data Bus: Please refer to the latest revision of the LAN91C96 Application Note for exact implementation of the CPU interface selected.
3. Control Signals: Please refer to the latest revision of the LAN91C96 Application Note for exact implementation of the CPU interface selected.

Miscellaneous:

1. Incorporate a large SMD resistor (SMD_1210) to connect the chassis ground to the digital ground. This will allow some flexibility at EMI testing for different grounding options. Leave the resistor out, the two grounds are separate. Short them together with a zero ohm resistor. Short them together with a cap or a ferrite bead for best performance.
2. Be sure to incorporate enough bulk capacitors (4.7 - 22 μ F caps) for each power plane.
3. PWRDWN (pin 66); this input to the LAN91C96 TQFP is a power down pin with an internal pull-up. This pin should be strapped low for normal operation. To enter the power down state, the pin should be pulled high or left unconnected.
4. nEN16 (pin 91); This input to the LAN91C96 TQFP has an internal pull-up. When low, the LAN91C96 is strapped for 16-bit bus operation mode. When high, the LAN91C96 works in 8-bit bus operation mode.
5. RESET (pin 65); This active high input to the LAN91C96 TQFP resets the device. This input must be high for more than 100 nS to reset the part. This particular input buffer has Schmitt Trigger Hysteresis characteristics.
6. nROM/nPCMCIA (pin 93); This input pin is used to configure the LAN91C96 TQFP in either Local Bus Mode or PCMCIA operation mode. Sampled at the end of reset, if this pin is connected to ground, the LAN91C96 will be configured for PCMCIA mode. Since it has an internal pull-up, if left unconnected or pulled high, the LAN91C96 will be configured for Local Bus Mode. In Local Bus Mode, this pin can be used as a ROM chip select.

LAN91C96 TQFP QuickCheck Pinout Table:

Use the following table to check the LAN91C96 TQFP shape in your schematic.

LAN91C96 TQFP							
Pin No.	Pin Name	Pin No.	Pin Name	Pin No.	Pin Name	Pin No.	Pin Name
1	ENEPP	26	A0	51	nMEMR	76	TXN
2	EEDO	27	A1	52	AEN	77	TXP
3	EEDI	28	A2	53	IOCHRDY	78	AVSS
4	EECS	29	VSS	54	VSS	79	AVDD
5	EESK	30	A3	55	D0	80	COLN
6	VSS	31	A4	56	D1	81	COLP
7	D8	32	A5	57	D2	82	RECN
8	D9	33	A6	58	D3	83	RECP
9	D10	34	A7	59	VDD	84	TPERXN
10	D11	35	A8	60	D4	85	TPERXP
11	VDD	36	A9	61	D5	86	AVSS
12	D12	37	A10	62	D6	87	AVSS
13	D13	38	VDD	63	D7	88	RBIAS
14	D14	39	A11	64	VSS	89	AVDD
15	D15	40	A12	65	RESET	90	nXENDEC
16	VSS	41	A13	66	PWRDWN	91	nEN16
17	INTR0	42	A14	67	nBSELED	92	VSS
18	INTR1	43	A15	68	nLNKLED	93	nROM
19	VDD	44	A16	69	nRXLED	94	XTAL1
20	INTR2	45	A17	70	nTXLED	95	XTAL2
21	INTR3	46	A18	71	AVDD	96	IOS0
22	VSS	47	A19	72	TPETXDP	97	IOS1
23	nIOCS16	48	VDD	73	TPETXN	98	VDD
24	nSBHE	49	nIORD	74	TPETXDN	99	IOS2
25	BALE	50	nIOWR	75	TPETXP	100	VSS

Reference Material:

1. SMSC LAN91C96 Data Sheet; check web site for latest revision.
2. SMSC LAN91C96 @ +3.3V EVB Schematic, Assembly No. 6254; check web site for latest revision.
3. SMSC LAN91C96 @ +3.3V EVB PCB, Assembly No. 6254; order PCB from web site.
4. SMSC LAN91C96 @ +3.3V EVB PCB Bill of Materials, Assembly No. 6254; check web site for latest revision.
5. SMSC LAN91C96 Application Notes AN 8-9 & AN 8-15; check web site for latest revision.
6. SMSC Suggested Magnetics Application Note 8-13; check web site for latest revision.